



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



## Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



# Tunnel Series DAT-040-12-02-00-00

## Direct-to-Air Thermoelectric Assembly



The Tunnel Series Direct-to-Air thermoelectric assembly is a thermoelectric based air conditioner designed to temperature control small chambers used in analytical and medical diagnostic instruments. The unique design offers premium fans pushing air across-high density heat sinks to minimize the number of air flow paths required to operate. The design utilizes custom thermoelectric modules to maximize cooling capacity with a high coefficient of performance. Moisture resistant insulation is used to keep condensation from penetrating the TEM cavity. The units operate on DC and are designed for an indoor lab use environment.

Americas: +1.919.597.7300  
Europe: +46.31.420530  
Asia: +86.755.2714.1166  
ets.sales@lairdtech.com  
[www.lairdtech.com](http://www.lairdtech.com)

Laird Part Number: 387000848

### FEATURES

- Compact form factor
- Improved sealing for moisture protection
- Reliable solid-state operation
- RoHS compliant

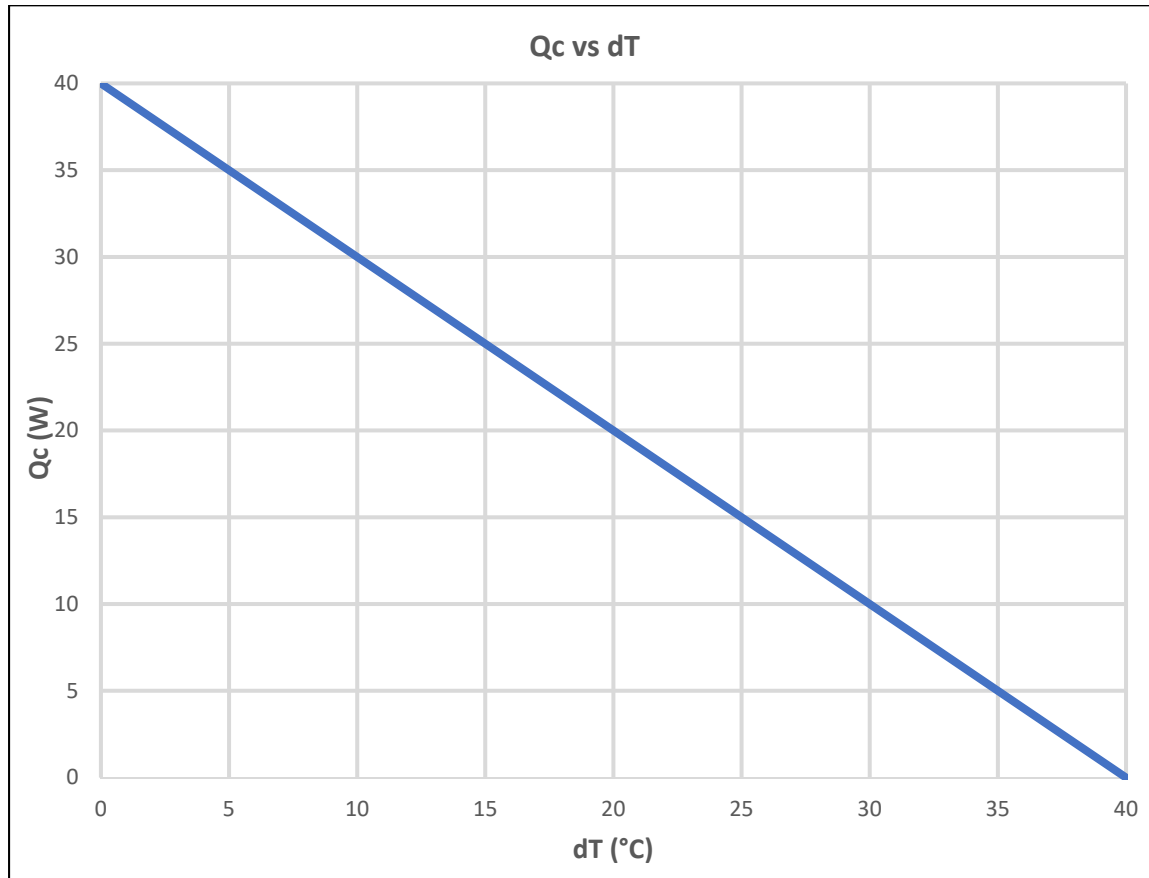
### APPLICATIONS

- Analytical storage compartment temperature control
- Medical diagnostic chamber refrigeration

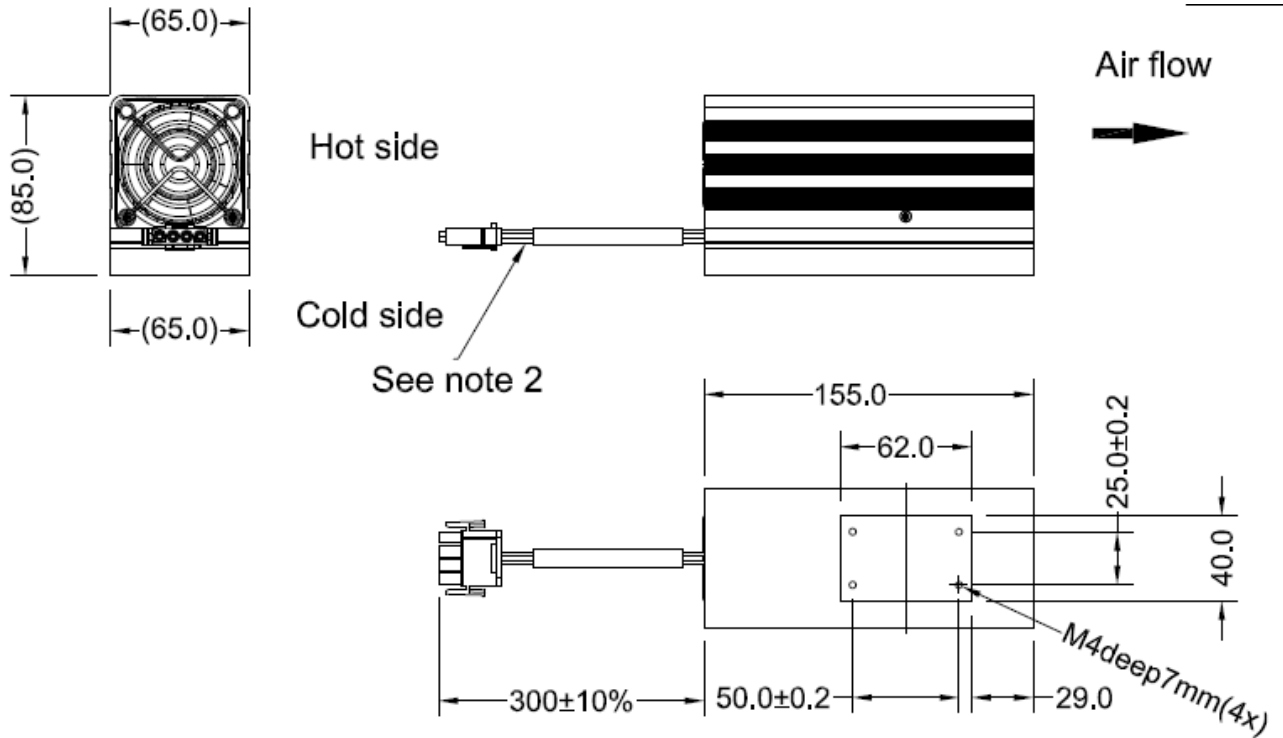
| SPECIFICATIONS           |   |
|--------------------------|---|
| TEA Model                | DAT,040,12,02,00,00   |
| Heat Transfer, Cold Side | Direct  |
| Heat Transfer, Hot Side  | Air   |
| Cooling Power            | 40 W @ $\Delta T=0^{\circ}\text{C}$ and $T_a=35^{\circ}\text{C}$ , Tolerance $\pm 10\%$ |
| TEM Input Power          |   |
| Voltage, Nominal         | 12 VDC  |
| Current, Nominal         | 2.9 Amps @ $\Delta T=0^{\circ}\text{C}$   |
| Fan Input Power          |   |
| Voltage, Nominal         | 12 VDC  |
| Current, Nominal         | 0.23 Amps   |
| Dimension (L x W x H)    | 155 x 65 x 86 mm  |
| Weight                   | 0.8kg   |
| Operating Temperature    | $-10^{\circ}\text{C}$ to $50^{\circ}\text{C}$   |
| Packaging                | Individual cardboard box  |

PERFORMANCE CURVES

TEA performance at  $T_h = 35^\circ\text{C}$



ISOMETRIC DRAWINGS



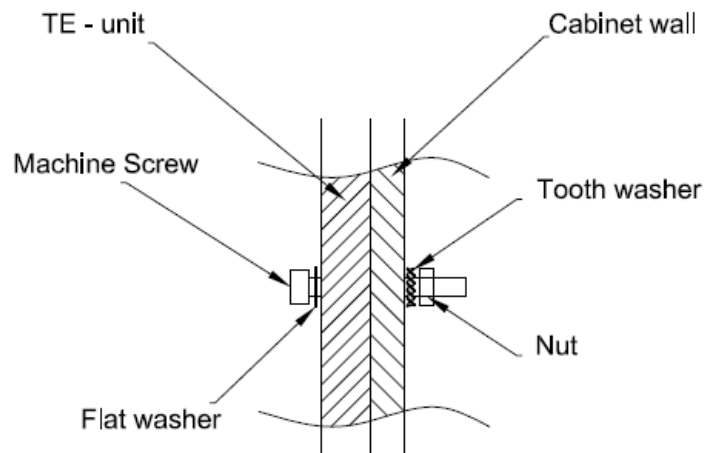
ELECTRICAL CONNECTIONS

| OBJECT         | WIRE TYPE | COLOR | TERMINAL                       | RECEPTICLE HOUSING             | POLE | PLUG HOUSING                   |
|----------------|-----------|-------|--------------------------------|--------------------------------|------|--------------------------------|
| TEM +          | AWG #20   | Red   | TE<br>Connectivity<br>350547-1 | TE<br>Connectivity<br>350779-1 | 1    | TE<br>Connectivity<br>350780-1 |
| TEM -          |           | Black |                                |                                | 2    |                                |
| FAN HOT SIDE + |           | White |                                |                                | 3    |                                |
| FAN HOT SIDE - |           | Green |                                |                                | 4    |                                |



## INSTALLATION INSTRUCTIONS

1. For operation below dew point, recommend to position unit in vertical direction with wires facing down to allow for condensation to run off of unit. Drop tray may be required to collect moisture from surfaces at temperatures below dew point.
2. TE should not be used as part of the structure and is recommended to be protected from external forces.
3. The input power to TEA should be protected with fuse. Fuse rating should withstand 150% of nominal current rating for 60 seconds. This is valid at  $T_a=35^{\circ}\text{C}$ . Fuse ratings for other ambient temperatures ( $x^{\circ}\text{C}$ ) can be calculated with the formula  $I [x^{\circ}\text{C}] = I [35^{\circ}\text{C}] / (1+0.005*(x-35))$ . This is valid when regulating with an On/Off regulation. At rapid temperature cycling where this is applicable, there can be a need for even higher fuse ratings.
4. Max ripple current on supply power should be  $\leq 5\%$ .
5. Switching power to TEMs at frequencies between 0.01Hz to 5KHz may degrade reliability and shorten life.



## SERVICE

- Units are generally maintenance free, however occasionally it is recommended to clean the heat sinks and fans of debris. This is best done with compressed air.

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